

LL4148

FEATURES :

- * Silicon Epitaxial Planar Diode
- * High reliability
- * Low reverse current
- * Low forward voltage drop
- * High speed switching
- * Pb / RoHS Free

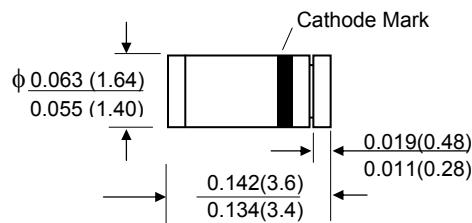
MECHANICAL DATA :

Case: MiniMELF Glass Case (SOD-80)

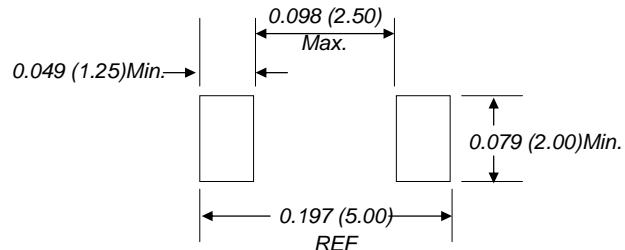
Weight: approx. 0.05g

HIGH SPEED SWITCHING DIODE

MiniMELF (SOD-80C)



Mounting Pad Layout



Dimensions in inches and (millimeters)

Maximum Ratings and Thermal Characteristics

(Rating at 25 °C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum Peak Reverse Voltage	V _{RM}	100	V
Maximum Reverse Voltage	V _R	75	V
Maximum Continuous Current ⁽¹⁾	I _F	200	mA
Maximum Average Forward Current	I _{F(AV)}	150	mA
Half Wave Rectification with Resistive Load, f ≥ 50Hz ⁽¹⁾			
Maximum Surge Forward Current at t < 1s and T _j = 25°C	I _{FSM}	500	mA
Maximum Power Dissipation ⁽¹⁾	P _D	500	mW
Thermal Resistance Junction to tie-point	R _{θJtp}	300	°C/W
Maximum Junction Temperature	T _J	175	°C
Storage Temperature Range	T _S	-65 to + 175	°C

Note: (1) Valid provided that electrodes are kept at ambient temperature

Electrical Characteristics

(T_j = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Reverse Current	I _R	V _R = 20 V	-	-	25	nA
		V _R = 75 V	-	-	5	µA
		V _R = 20 V , T _j = 150 °C	-	-	50	µA
Forward Voltage	V _F	I _F = 10 mA	-	-	1	V
Diode Capacitance	C _d	f = 1MHz ; V _R = 0	-	-	4	pF
Reverse Recovery Time	T _{rr}	I _F = 10 mA , I _R = 1mA, V _R = 6 V, R _L = 100Ω	-	-	4	ns

RATING AND CHARACTERISTIC CURVES (LL4148)

**FIG. 1 ADMISSIBLE POWER DISSIPATION
VERSUS AMBIENT TEMPERATURE**

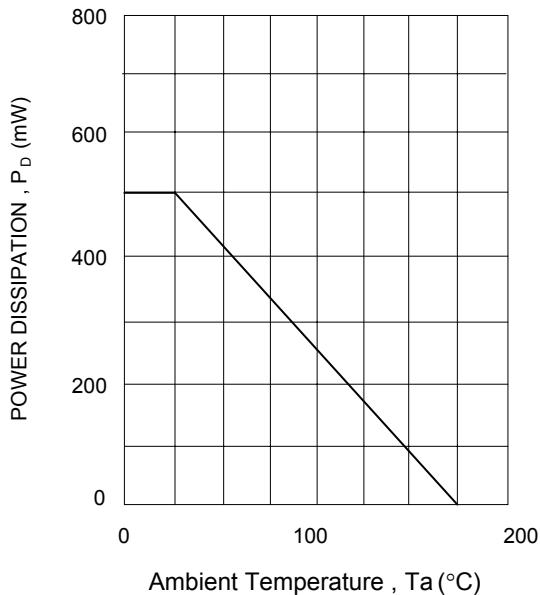
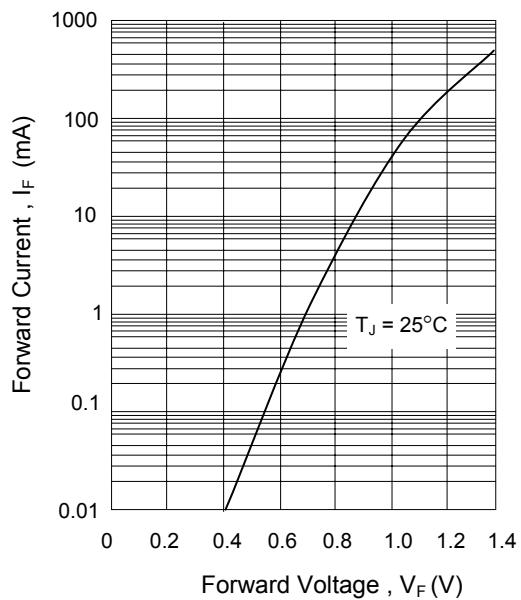
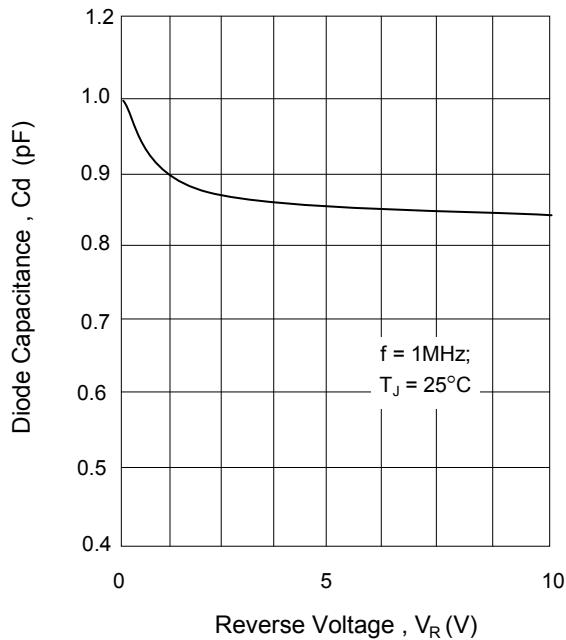


FIG. 2 TYPICAL FORWARD VOLTAGE



**FIG. 3 TYPICAL DIODE CAPACITANCE AS
A FUNCTION OF REVERSE VOLTAGE**



**FIG. 4 TYPICAL REVERSE CURRENT
VERSUS JUNCTION TEMPERATURE**

